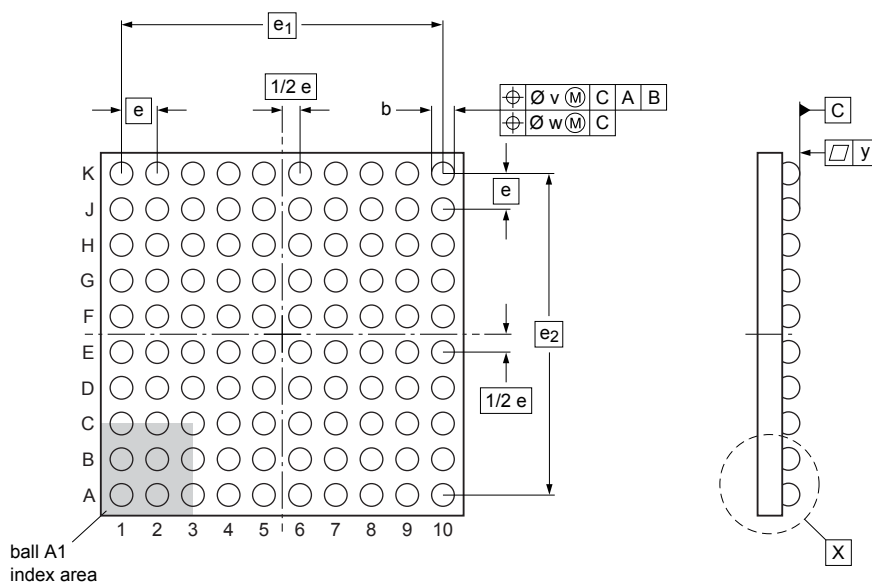
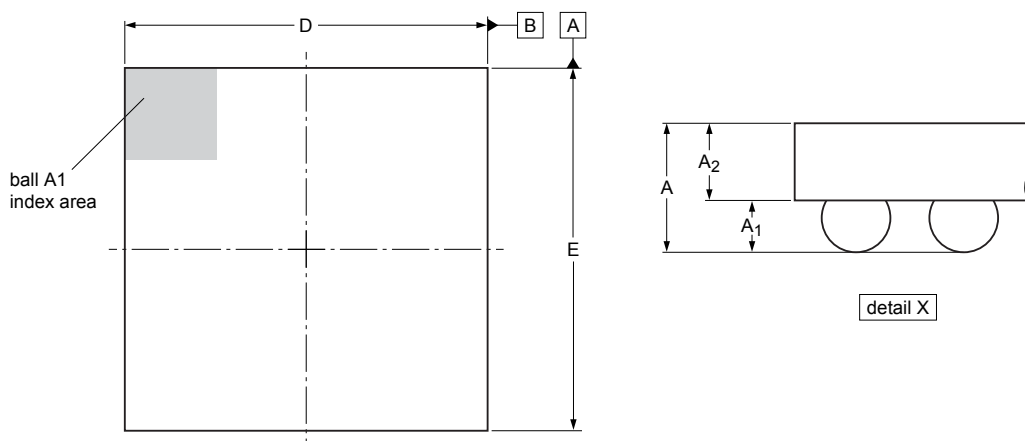


WLCSP100: wafer level chip-scale package; 100 balls; 5.074 x 5.074 x 0.6 mm

LPC1768UK



Dimensions (mm are the original dimensions)

Unit	A	A ₁	A ₂	b	D	E	e	e ₁	e ₂	v	w	y
max	0.65	0.27	0.385	0.35	5.104	5.104						
mm nom	0.60	0.24	0.360	0.32	5.074	5.074	0.5	4.5	4.5	0.15	0.05	0.05
min	0.55	0.21	0.335	0.29	5.044	5.044						

wlcsp100_lpc1768uk_po

Outline version	References			European projection	Issue date
	IEC	JEDEC	JEITA		
LPC1768UK					11-10-19 13-11-04